

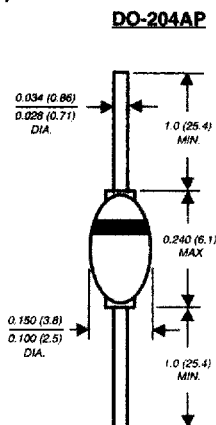
BYV27-50 THRU BYV27-200

GLASS PASSIVATED FAST EFFICIENT RECTIFIER

Reverse Voltage - 50 to 200 Volts

Forward Current - 2.0 Amperes

PATENTED *



Dimensions in inches and (millimeters)

* Brazed-lead assembly is covered by Patent No. 3,930,306

FEATURES

- ♦ High temperature metallurgically bonded construction
- ♦ Glass passivated cavity-free junction
- ♦ Superfast recovery time for high efficiency
- ♦ Low forward voltage, high current capability
- ♦ Capable of meeting environmental standards of MIL-S-19500
- ♦ Hermetically sealed package
- ♦ Low leakage current
- ♦ High surge current capability
- ♦ High temperature soldering guaranteed:
350°C/10 seconds, 0.375" (9.5mm) lead length,
5 lbs. (2.3kg) tension

MECHANICAL DATA

Case: JEDEC DO-204AP solid glass body
Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026
Polarity: Color band denotes cathode end
Mounting Position: Any
Weight: 0.02 ounce, 0.56 gram

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

| | SYMBOLS | BYV27-50 | BYV27-100 | BYV27-150 | BYV27-200 | UNITS |
|---|--------------------------------------|---|-----------|--------------|-----------|-------|
| Maximum repetitive peak reverse voltage | V _{RRM} | 50 | 100 | 150 | 200 | Volts |
| Maximum RMS voltage | V _{RMS} | 35 | 70 | 105 | 140 | Volts |
| Maximum DC blocking voltage | V _{DC} | 50 | 100 | 150 | 200 | Volts |
| Minimum reverse breakdown voltage at 100 μA | V _{BR} | 55 | 110 | 165 | 220 | Volts |
| Maximum average forward rectified current 0.375" (9.5mm) lead length at T _L =85°C | I _(AV) | 2.0 | | | | Amps |
| Peak forward surge current 10ms single half sine-wave superimposed on rated load at T _J =175°C | I _{FSM} | 50.0 | | | | Amps |
| Maximum instantaneous forward voltage at 3.0A | V _F | T _J =25°C T _J =175°C | | 1.07 0.88 | | Volts |
| Maximum DC reverse current at rated DC blocking voltage | I _R | T _A =25°C T _A =165°C | | 1.0 150.0 | | μA |
| Maximum reverse recovery time (NOTE 1) | t _{rr} | 25.0 | | | | ns |
| Typical junction capacitance (NOTE 2) | C _J | 45.0 | | | | pF |
| Typical thermal resistance (NOTE 3, 4) | R _{θJA} R _{θJL} | 65.0 20.0 | | | | °C/W |
| Operating junction and storage temperature range | T _J , T _{STG} | -65 to +175 | | | | °C |

NOTES:

- (1) Reverse recovery test conditions: I_F=0.5A, I_R=1.0A, I_m=0.25A
- (2) Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts
- (3) Thermal resistance from junction to lead at 0.375" (9.5mm) lead length with both leads attached to heatsinks
- (4) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length and mounted on P.C.B. with 0.5 x 0.5" (12 x 12mm) copper pads

RATINGS AND CHARACTERISTIC CURVES BYV27-50 THRU BYV27-200

FIG. 1 - MAXIMUM FORWARD CURRENT DERATING CURVE

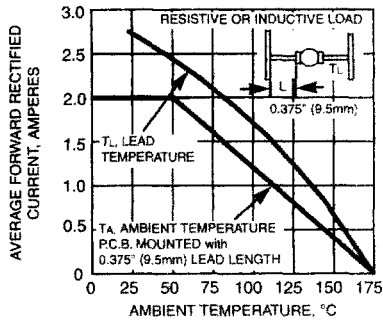


FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

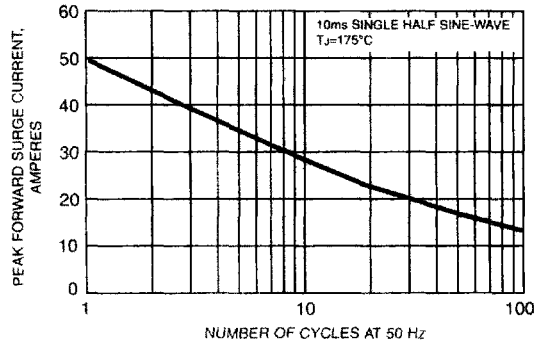


FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

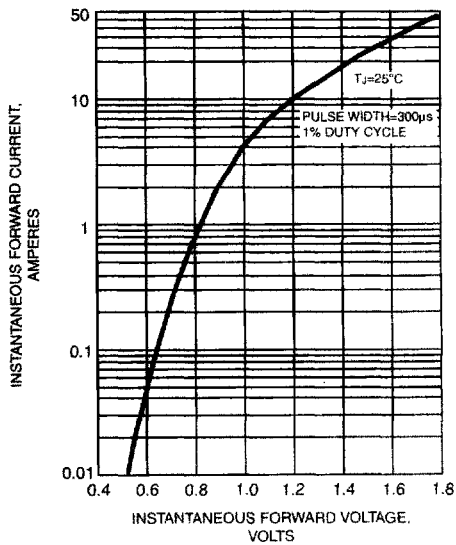


FIG. 4 - TYPICAL REVERSE LEAKAGE CHARACTERISTICS

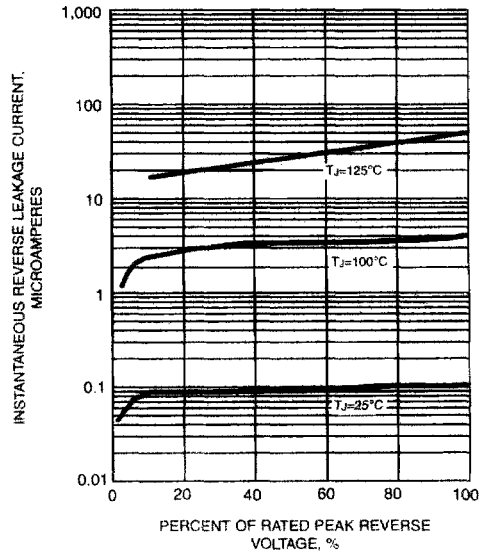


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

